Electronic Pat							
Application Number:	107	10722818					
Filing Date:	25-	25-Nov-2003					
Title of Invention:	VEI	VERTICAL STRUCTURE THIN FILM TRANSISTOR					
First Named Inventor/Applicant Name:	Sec	Seong Hyun Kim					
Filer:	Eric	Eric S. Hyman/Linda Metz					
Attorney Docket Number:	201	2013P135					
Filed as Small Entity	,						
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
					755		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:	·			
Miscellaneous:				
Printed copy of patent - no color	8001	1	3	3
	Tot	Total in USD (\$)		